



2D Solution 3D AFVI

SMS/ITS 2D marking Solution

- Panel tray to panel tray
- Application device: All kind of package substrate (size: max 510mm x 610mm)
- Marking position inspection: tilt, shrinkage-reference point
- Warp control: less 50um
- Strip marking information: LOT+panel+strip information
- Block marking: LOT+panel+strip+block number

